CALL FOR PAPERS

KEY DATES

ABSTRACT SUBMISSION DEADLINE

April 14

AUTHOR NOTIFICATIONJune 3

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PUBLICATION SUBMISSION DEADLINE

August 31

ORGANIZING COMMITTEE

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The 2025 IEEE International Ultrasonics Symposium will be the 62nd edition of this conference and will be held on September 15-18, 2025 in Utrecht, Netherlands Utrecht is famous for its Dom Tower (the highest historic building in the Netherlands), the beautiful canals with dwarf cellars, lively restaurants and cafés, and Nijntje (Miffy). Doppler ultrasound was experimentally demonstrated in Utrecht. It is an eco-friendly city in which the bike prevails rather than the car. The conference building is located next to the railway station that has the highest turnover of daily passengers of Europe with excellent connections to all major Dutch cities. Amsterdam is only 25 minutes away The conference encourages in-person attendance but also accommodates online attendees.

SUBMISSION TOPICS

Abstracts should be submitted according to the information posted on the conference web page. Each abstract will receive careful review and evaluation by the symposium Technical Program Committee based on originality of the work, contribution to the state of the art and overall interest to the ultrasonics community. Papers are solicited describing original work in the field of ultrasonics.

- » Group 1: Medical Ultrasonics
- » Group 2: Sensors, NDE & Industrial Applications
- » Group 3: Physical Acoustics
- » Group 4: Microacoustics SAW, FBAR & MEMS
- » Group 5: Transducers & Transducer Materials

STUDENT PAPER COMPETITION AND TRAVEL SUPPORT

Students submitting abstracts are invited to participate in a student paper competition. To participate, the student must be the lead author and present their paper. Limited funds are available to support travel for IEEE UFFC student member attendees at the 2025 symposium. Awards will be given on a competitive basis.



